

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Moisture Resistance	10 cycles, 24 hours per cycle	MIL-STD-202, Method 106, Condition A, except 50°C and end point electrical test done within 12 hours
Solderability	10X Magnification	J-STD-002, 95% Coverage
Resistance to Solder Heat	260°C for 10 seconds	MIL-STD-202, Method 210, Condition B
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215
Terminal Strength	4 1/2 Pound Pull	MIL-STD-202, Method 211, Condition A

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Specification	Test/Inspection Condition	Reference/Spec
Gross Leak	125°C Bubble Test	MIL-STD-202, Method 112, Condition D
Barometric Pressure	100,000 Feet	MIL-STD-202, Method 105, Condition D